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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

| | |
|----------------------------|---|
| Product Status | Active |
| Core Processor | PIC |
| Core Size | 8-Bit |
| Speed | 20MHz |
| Connectivity | - |
| Peripherals | POR, WDT |
| Number of I/O | 20 |
| Program Memory Size | 3KB (2K x 12) |
| Program Memory Type | OTP |
| EEPROM Size | - |
| RAM Size | 72 x 8 |
| Voltage - Supply (Vcc/Vdd) | 4.5V ~ 5.5V |
| Data Converters | - |
| Oscillator Type | External |
| Operating Temperature | 0°C ~ 70°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 28-SSOP (0.209", 5.30mm Width) |
| Supplier Device Package | 28-SSOP |
| Purchase URL | https://www.e-xfl.com/product-detail/microchip-technology/pic16c57-hs-ss |

PIC16C5X

NOTES:

FIGURE 6-5: PIC16C57/CR57 REGISTER FILE MAP

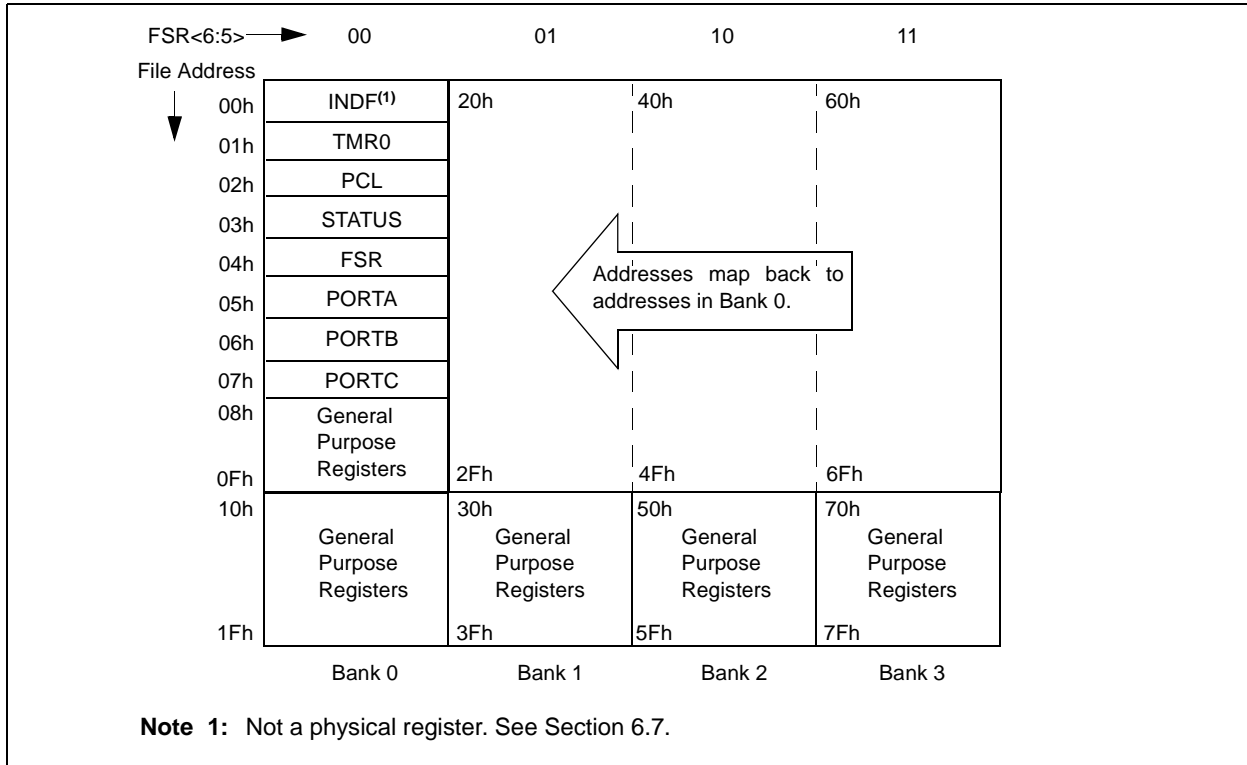
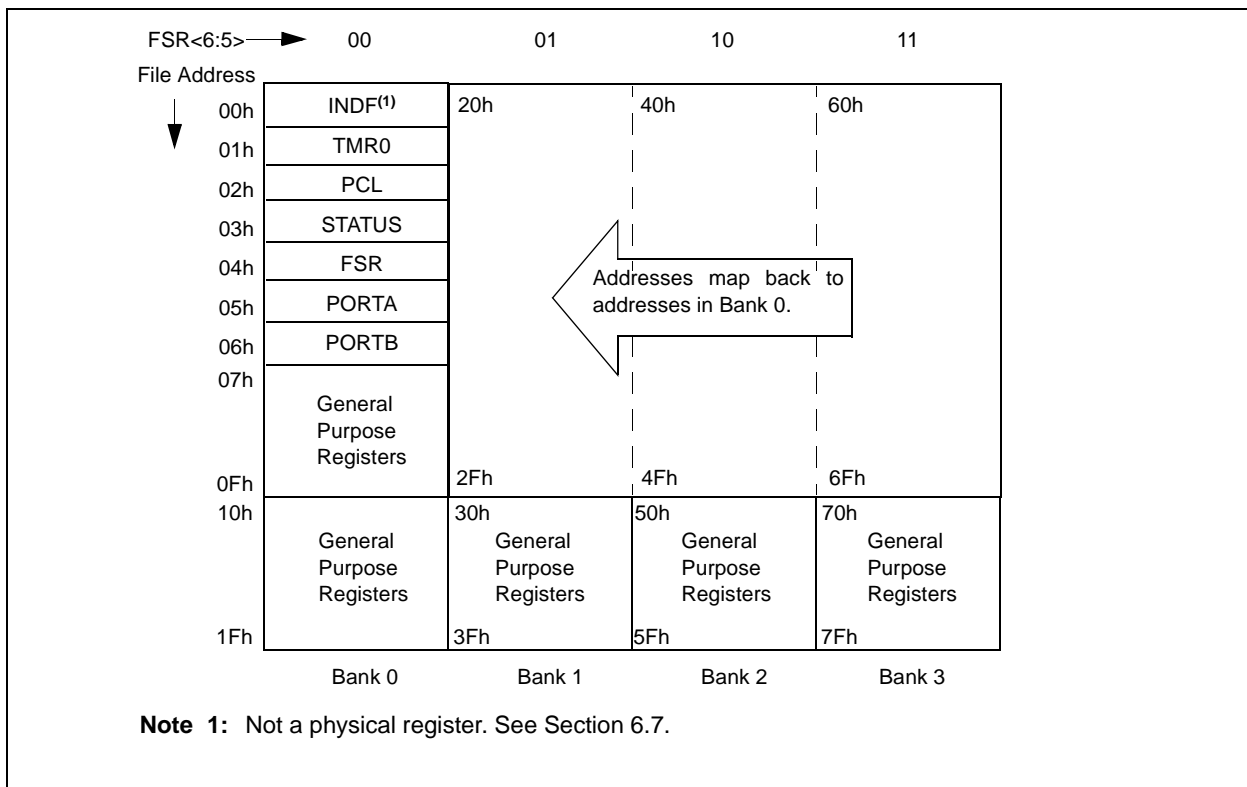


FIGURE 6-6: PIC16C58/CR58 REGISTER FILE MAP



6.3 STATUS Register

This register contains the arithmetic status of the ALU, the RESET status and the page preselect bits for program memories larger than 512 words.

The STATUS Register can be the destination for any instruction, as with any other register. If the STATUS Register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the \overline{TO} and \overline{PD} bits are not

writable. Therefore, the result of an instruction with the STATUS Register as destination may be different than intended.

For example, `CLRF STATUS` will clear the upper three bits and set the Z bit. This leaves the STATUS Register as `000u u1uu` (where u = unchanged).

It is recommended, therefore, that only `BCF`, `BSF` and `MOVWF` instructions be used to alter the STATUS Register because these instructions do not affect the Z, DC or C bits from the STATUS Register. For other instructions which do affect STATUS Bits, see Section 10.0, Instruction Set Summary.

REGISTER 6-1: STATUS REGISTER (ADDRESS: 03h)

| R/W-0 | R/W-0 | R/W-0 | R-1 | R-1 | R/W-x | R/W-x | R/W-x |
|-------|-------|-------|-----------------|-----------------|-------|-------|-------|
| PA2 | PA1 | PA0 | \overline{TO} | \overline{PD} | Z | DC | C |
| bit 7 | | | | | | | |
| | | | | | | | bit 0 |

bit 7: **PA2:** This bit unused at this time.

Use of the PA2 bit as a general purpose read/write bit is not recommended, since this may affect upward compatibility with future products.

bit 6-5: **PA<1:0>:** Program page preselect bits (PIC16C56/CR56)(PIC16C57/CR57)(PIC16C58/CR58)

00 = Page 0 (000h - 1FFh) - PIC16C56/CR56, PIC16C57/CR57, PIC16C58/CR58

01 = Page 1 (200h - 3FFh) - PIC16C56/CR56, PIC16C57/CR57, PIC16C58/CR58

10 = Page 2 (400h - 5FFh) - PIC16C57/CR57, PIC16C58/CR58

11 = Page 3 (600h - 7FFh) - PIC16C57/CR57, PIC16C58/CR58

Each page is 512 words.

Using the PA<1:0> bits as general purpose read/write bits in devices which do not use them for program page preselect is not recommended since this may affect upward compatibility with future products.

bit 4: **\overline{TO} :** Time-out bit

1 = After power-up, `CLRWDT` instruction, or `SLEEP` instruction

0 = A WDT time-out occurred

bit 3: **\overline{PD} :** Power-down bit

1 = After power-up or by the `CLRWDT` instruction

0 = By execution of the `SLEEP` instruction

bit 2: **Z:** Zero bit

1 = The result of an arithmetic or logic operation is zero

0 = The result of an arithmetic or logic operation is not zero

bit 1: **DC:** Digit carry/borrow bit (for `ADDWF` and `SUBWF` instructions)

ADDWF

1 = A carry from the 4th low order bit of the result occurred

0 = A carry from the 4th low order bit of the result did not occur

SUBWF

1 = A borrow from the 4th low order bit of the result did not occur

0 = A borrow from the 4th low order bit of the result occurred

bit 0: **C:** Carry/borrow bit (for `ADDWF`, `SUBWF` and `RRF`, `RLF` instructions)

ADDWF

1 = A carry occurred

0 = A carry did not occur

SUBWF

1 = A borrow did not occur

0 = A borrow occurred

RRF or RLF

Loaded with LSb or MSb, respectively

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

1 = bit is set

0 = bit is cleared

x = bit is unknown

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6.5.1 PAGING CONSIDERATIONS – PIC16C56/CR56, PIC16C57/CR57 AND PIC16C58/CR58

If the Program Counter is pointing to the last address of a selected memory page, when it increments it will cause the program to continue in the next higher page. However, the page preselect bits in the STATUS Register will not be updated. Therefore, the next `GOTO`, `CALL` or modify PCL instruction will send the program to the page specified by the page preselect bits (PA0 or PA<1:0>).

For example, a `NOP` at location 1FFh (page 0) increments the PC to 200h (page 1). A `GOTO xxx` at 200h will return the program to address xxh on page 0 (assuming that PA<1:0> are clear).

To prevent this, the page preselect bits must be updated under program control.

6.5.2 EFFECTS OF RESET

The Program Counter is set upon a RESET, which means that the PC addresses the last location in the last page (i.e., the RESET vector).

The STATUS Register page preselect bits are cleared upon a RESET, which means that page 0 is preselected.

Therefore, upon a RESET, a `GOTO` instruction at the RESET vector location will automatically cause the program to jump to page 0.

6.6 Stack

PIC16C5X devices have a 10-bit or 11-bit wide, two-level hardware push/pop stack.

A `CALL` instruction will push the current value of stack 1 into stack 2 and then push the current program counter value, incremented by one, into stack level 1. If more than two sequential `CALL`'s are executed, only the most recent two return addresses are stored.

A `RETLW` instruction will pop the contents of stack level 1 into the program counter and then copy stack level 2 contents into level 1. If more than two sequential `RETLW`'s are executed, the stack will be filled with the address previously stored in level 2. Note that the W Register will be loaded with the literal value specified in the instruction. This is particularly useful for the implementation of data look-up tables within the program memory.

For the `RETLW` instruction, the PC is loaded with the Top of Stack (TOS) contents. All of the devices covered in this data sheet have a two-level stack. The stack has the same bit width as the device PC, therefore, paging is not an issue when returning from a subroutine.

PIC16C5X

FIGURE 8-3: TIMER0 TIMING: INTERNAL CLOCK/NO PRESCALER

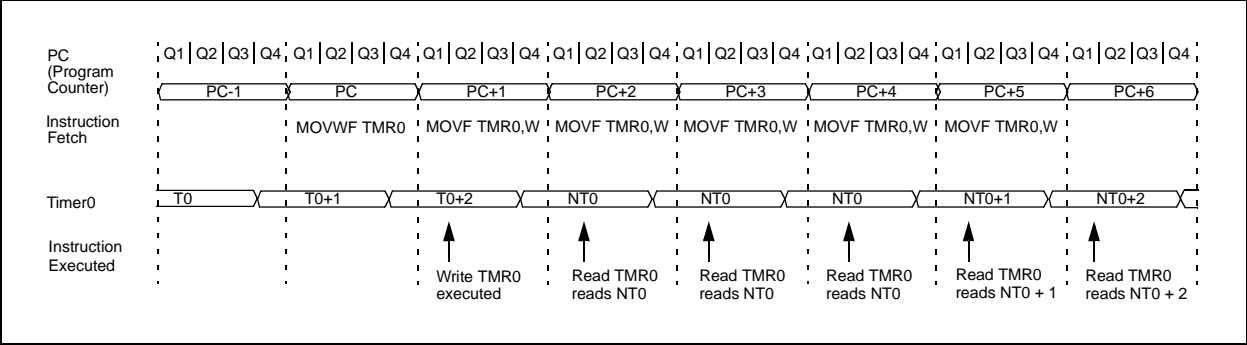


FIGURE 8-4: TIMER0 TIMING: INTERNAL CLOCK/PRESCALER 1:2

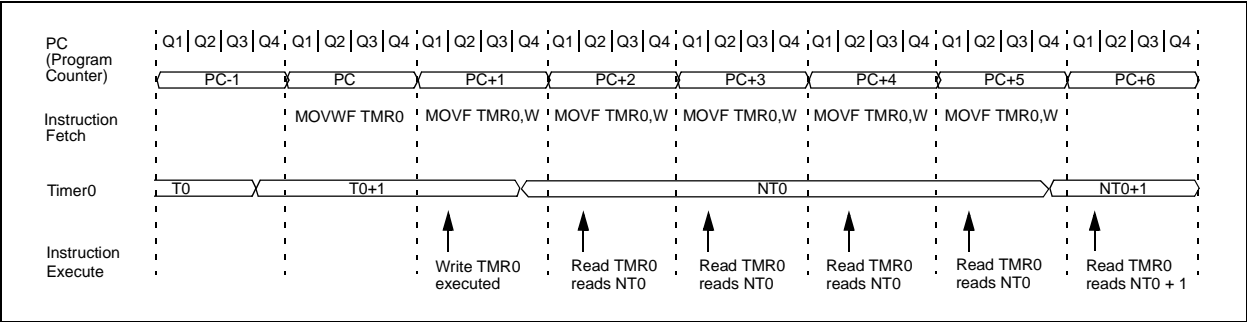


TABLE 8-1: REGISTERS ASSOCIATED WITH TIMER0

| Address | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Value on Power-on Reset | Value on MCLR and WDT Reset |
|---------|--------|--|-------|-------|-------|-------|-------|-------|-------|-------------------------|-----------------------------|
| 01h | TMR0 | Timer0 - 8-bit real-time clock/counter | | | | | | | | xxxx xxxx | uuuu uuuu |
| N/A | OPTION | — | — | T0CS | T0SE | PSA | PS2 | PS1 | PS0 | --11 1111 | --11 1111 |

Legend: x = unknown, u = unchanged, - = unimplemented. Shaded cells not used by Timer0.

TABLE 11-1: DEVELOPMENT TOOLS FROM MICROCHIP

| | PIC12CXX | PIC14000 | PIC16C5X | PIC16C6X | PIC16CXX | PIC16C7X | PIC16C7XX | PIC16C8X | PIC16F8XX | PIC16G9XX | PIC17C4X | PIC17C7XX | PIC18CXX2 | PIC18FXX | 24CXX/ 25CXX/ 93CXX | HCXXX | MCRFXXX | MCP2510 |
|---------------------------|---|----------|----------|----------|----------|----------|-----------|----------|-----------|-----------|----------|-----------|-----------|----------|---------------------------|-------|---------|---------|
| Software Tools | MPLAB® Integrated Development Environment | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | | |
| | MPLAB® C17 C Compiler | | | | | | | | | | ✓ | | ✓ | | | | | |
| | MPLAB® C18 C Compiler | | | | | | | | | | | | ✓ | | | | | |
| Emulators | MPASM™ Assembler/ MPLINK™ Object Linker | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | | |
| | MPLAB® ICE In-Circuit Emulator | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | | | |
| | ICEPIC™ In-Circuit Emulator | ✓ | | ✓ | ✓ | | ✓ | ✓ | | ✓ | | | | | | | | |
| Debugger | MPLAB® ICD In-Circuit Debugger | | | ✓ | ✓ | ✓ | | | ✓ | | | | | ✓ | | | | |
| Programmers | PICSTART® Plus Entry Level Development Programmer | ✓ | ✓ | ✓ | ✓ | ✓ | | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | | | |
| | PRO MATE® II Universal Device Programmer | ✓ | ✓ | ✓ | ✓ | ✓ | | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | ✓ | | |
| Demo Boards and Eval Kits | PICDEM™ 1 Demonstration Board | | ✓ | | | † | | ✓ | | | ✓ | | | | | | | |
| | PICDEM™ 2 Demonstration Board | | | | † | † | | | | | | | ✓ | | | | | |
| | PICDEM™ 3 Demonstration Board | | | | | | | | | ✓ | | | | | | | | |
| | PICDEM™ 14A Demonstration Board | | ✓ | | | | | | | | | | | | | | | |
| | PICDEM™ 17 Demonstration Board | | | | | | | | | | | ✓ | | | | | | |
| | KEELOQ® Evaluation Kit | | | | | | | | | | | | | | | ✓ | | |
| | KEELOQ® Transponder Kit | | | | | | | | | | | | | | | ✓ | | |
| | microID™ Programmer's Kit | | | | | | | | | | | | | | | | ✓ | |
| | 125 kHz microID™ Developer's Kit | | | | | | | | | | | | | | | | ✓ | |
| | 125 kHz Anticollision microID™ Developer's Kit | | | | | | | | | | | | | | | | ✓ | |
| | 13.56 MHz Anticollision microID™ Developer's Kit | | | | | | | | | | | | | | | | ✓ | |
| | MCP2510 CAN Developer's Kit | | | | | | | | | | | | | | | | ✓ | ✓ |

* Contact the Microchip Technology Inc. web site at www.microchip.com for information on how to use the MPLAB® ICD In-Circuit Debugger (DV164001) with PIC16C62, 63, 64, 65, 72, 73, 74, 76, 77.

** Contact Microchip Technology Inc. for availability date.

† Development tool is available on select devices.

PIC16C5X

NOTES:

PIC16C5X

12.7 Timing Diagrams and Specifications

FIGURE 12-2: EXTERNAL CLOCK TIMING - PIC16C54/55/56/57

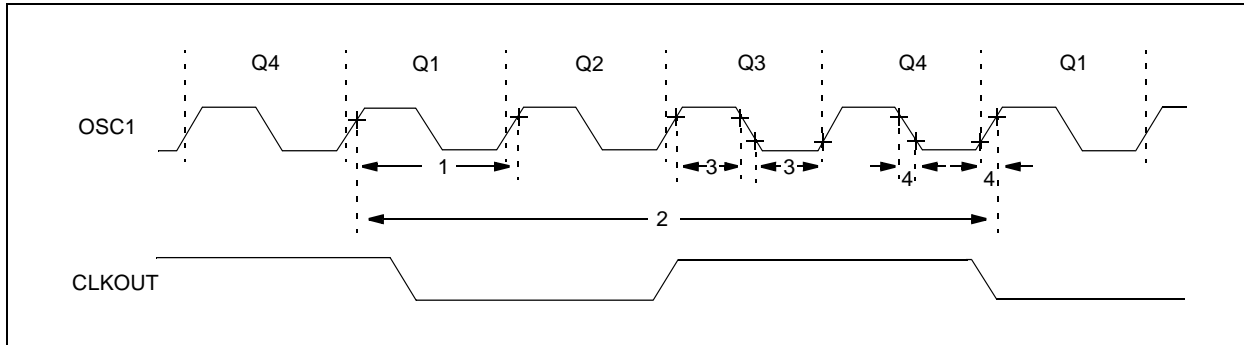


TABLE 12-1: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C54/55/56/57

| Standard Operating Conditions (unless otherwise specified) | | | | | | | |
|--|--------|---|-----|------|-----|-------|------------------------|
| AC Characteristics | | Operating Temperature | | | | | |
| | | 0°C ≤ TA ≤ +70°C for commercial | | | | | |
| | | −40°C ≤ TA ≤ +85°C for industrial | | | | | |
| | | −40°C ≤ TA ≤ +125°C for extended | | | | | |
| Param No. | Symbol | Characteristic | Min | Typ† | Max | Units | Conditions |
| 1A | FOSC | External CLKIN Frequency ⁽¹⁾ | DC | — | 4.0 | MHz | XT osc mode |
| | | | DC | — | 10 | MHz | 10 MHz mode |
| | | | DC | — | 20 | MHz | HS osc mode (Comm/Ind) |
| | | | DC | — | 16 | MHz | HS osc mode (Ext) |
| | | | DC | — | 40 | kHz | LP osc mode |
| | | Oscillator Frequency ⁽¹⁾ | DC | — | 4.0 | MHz | RC osc mode |
| | | | 0.1 | — | 4.0 | MHz | XT osc mode |
| | | | 4.0 | — | 10 | MHz | 10 MHz mode |
| | | | 4.0 | — | 20 | MHz | HS osc mode (Comm/Ind) |
| | | | 4.0 | — | 16 | MHz | HS osc mode (Ext) |
| | | | DC | — | 40 | kHz | LP osc mode |

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.

When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

2: Instruction cycle period (TCY) equals four times the input oscillator time base period.

13.5 Timing Parameter Symbolology and Load Conditions

The timing parameter symbols have been created with one of the following formats:

- 1. TppS2ppS
- 2. TppS

| | |
|-------------|--------|
| T | T |
| F Frequency | T Time |

Lowercase letters (pp) and their meanings:

| | |
|------------------------|--------------------|
| pp | mc MCLR |
| 2 to | osc oscillator |
| ck CLKOUT | os OSC1 |
| cy cycle time | t0 T0CKI |
| drt device reset timer | wdt watchdog timer |
| io I/O port | |

Uppercase letters and their meanings:

| | |
|--------------------------|----------------|
| S | P Period |
| F Fall | R Rise |
| H High | V Valid |
| I Invalid (Hi-impedance) | Z Hi-impedance |
| L Low | |

FIGURE 13-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS - PIC16CR54A

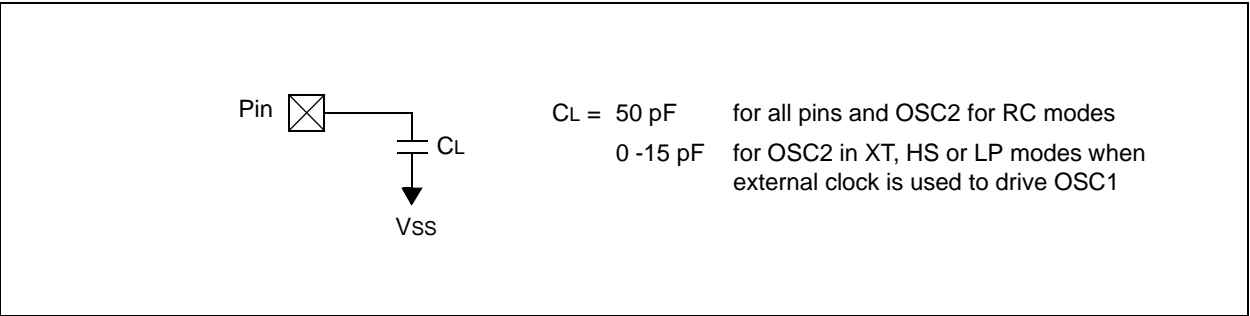


FIGURE 14-4: TYPICAL RC OSC
FREQUENCY vs. VDD,
CEXT = 300 PF

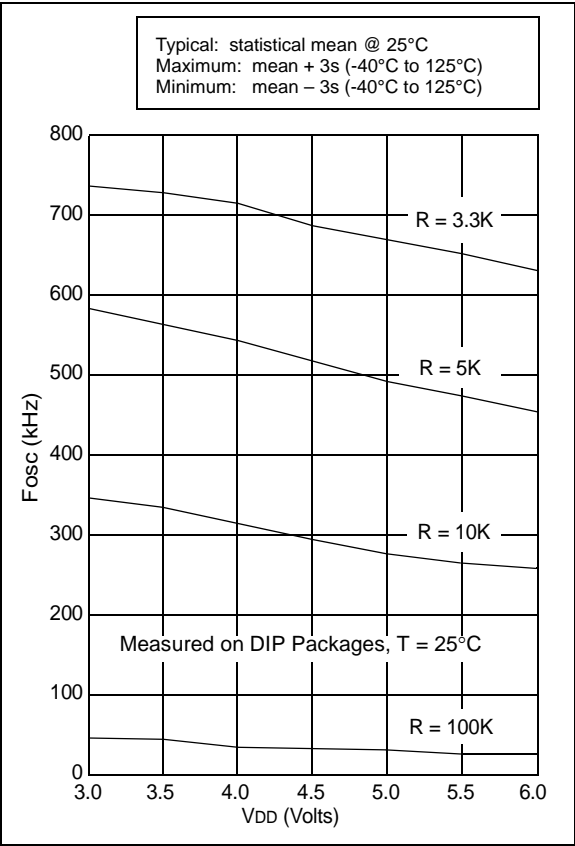


FIGURE 14-5: TYPICAL IPD vs. VDD,
WATCHDOG DISABLED

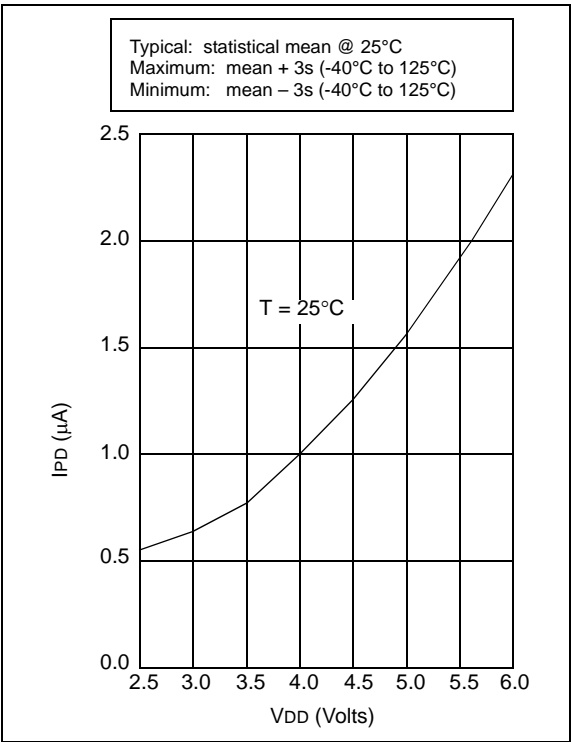


FIGURE 14-13: MAXIMUM IDD VS. FREQUENCY (EXTERNAL CLOCK, -40°C TO +85°C)

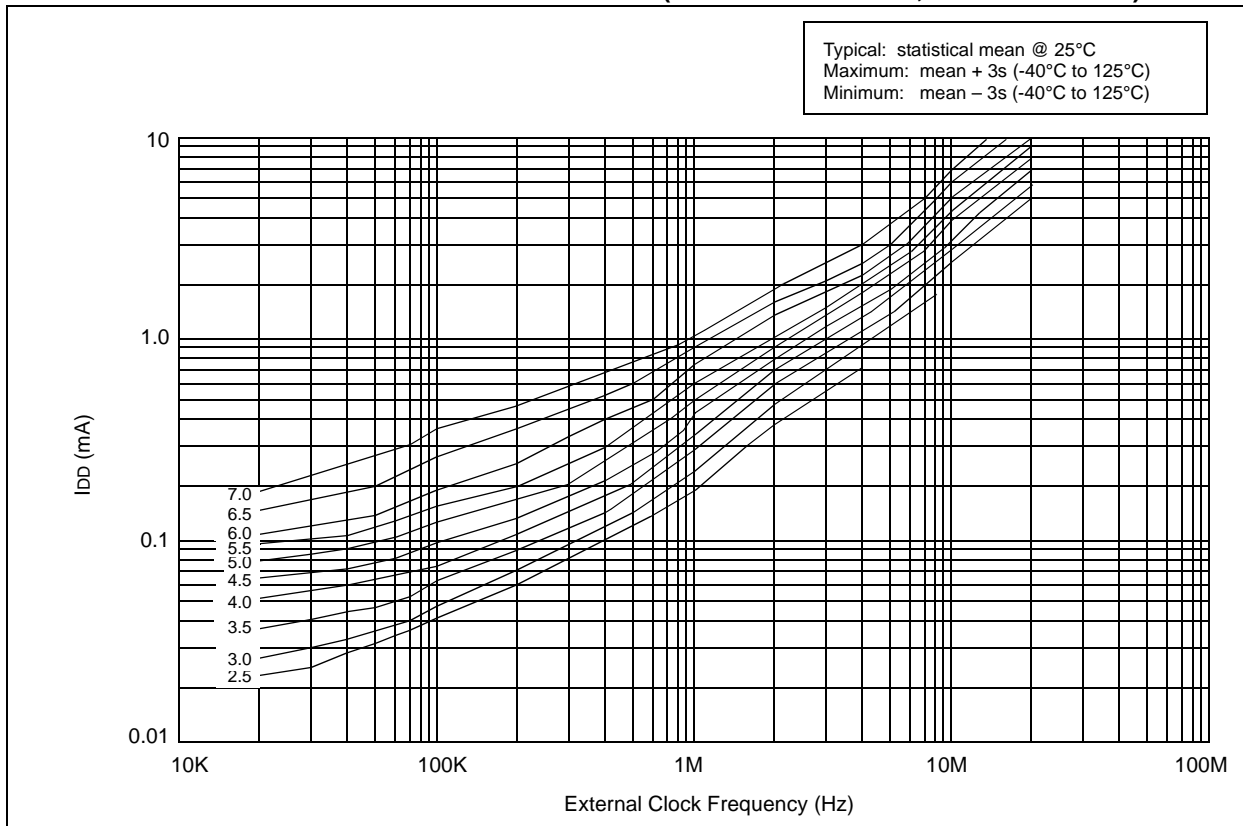
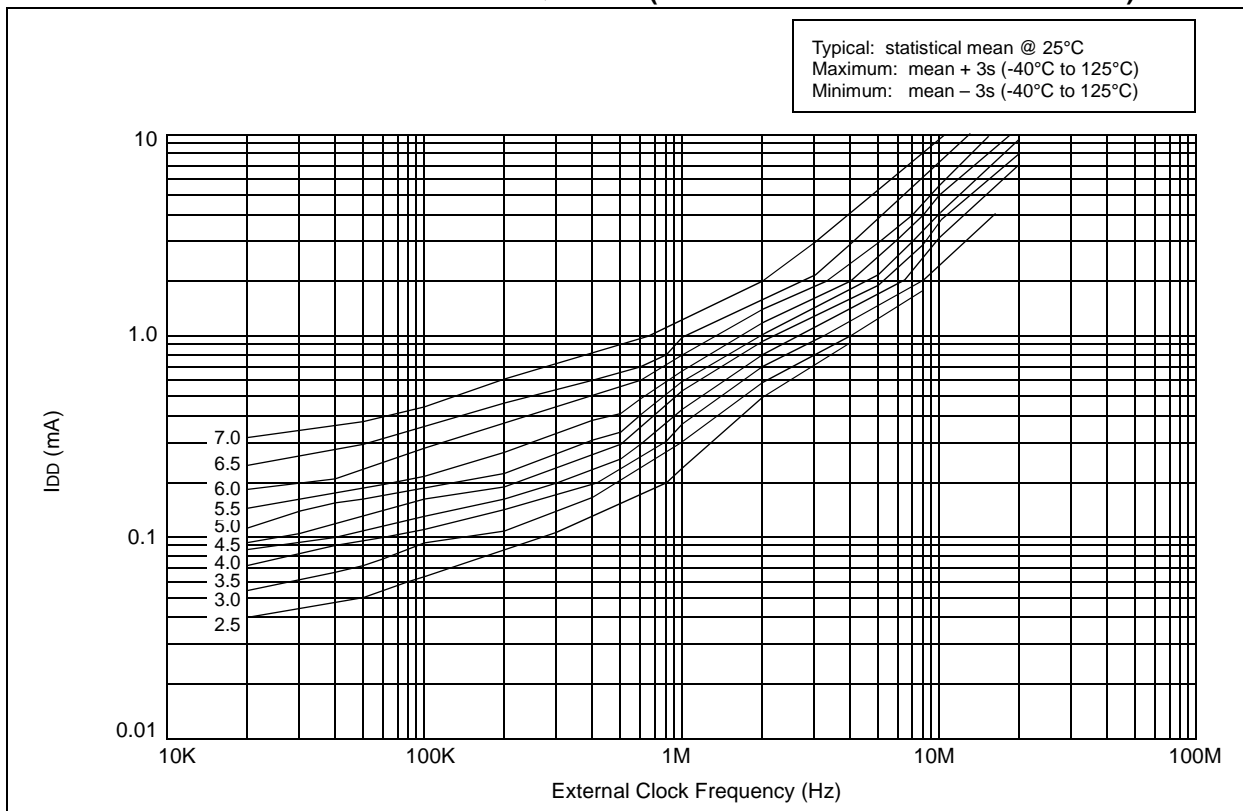


FIGURE 14-14: MAXIMUM I_{DD} vs. FREQUENCY (EXTERNAL CLOCK -55°C TO +125°C)

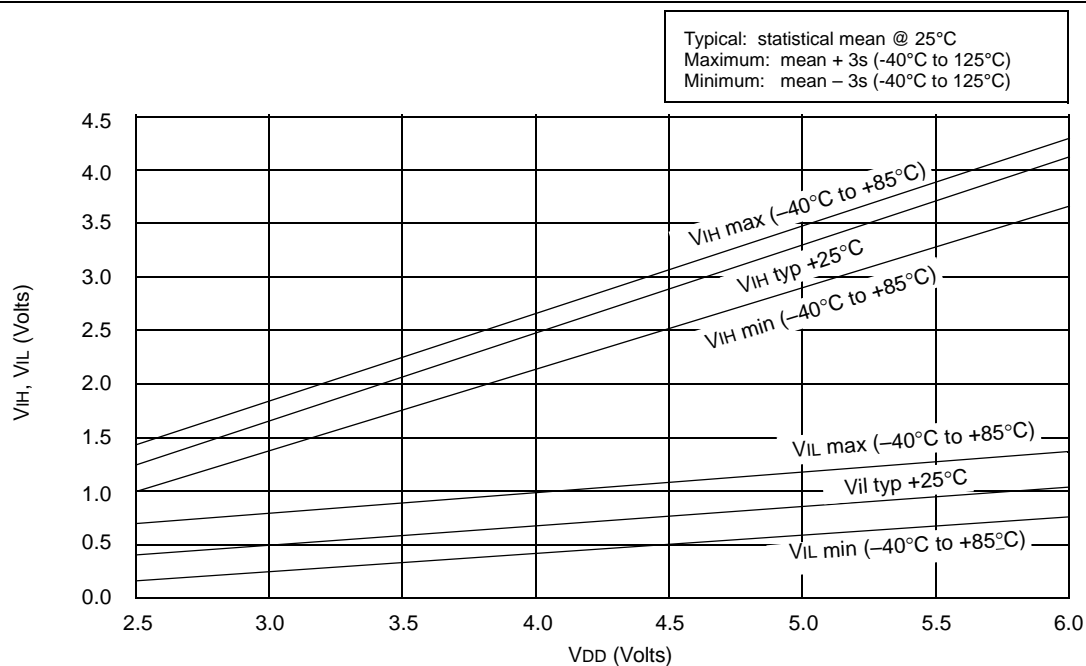


PIC16C5X

NOTES:

PIC16C5X

FIGURE 16-9: V_{IH} , V_{IL} OF \overline{MCLR} , $T0CKI$ AND $OSC1$ (IN RC MODE) vs. V_{DD}



Note: These input pins have Schmitt Trigger input buffers.

FIGURE 16-20: PORTA, B AND C I_{OH} vs. V_{OH}, V_{DD} = 3V

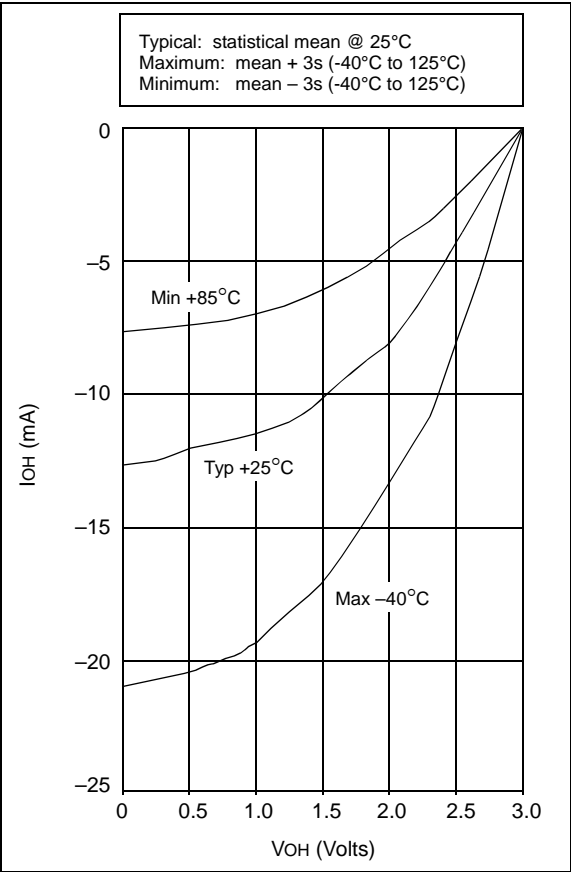
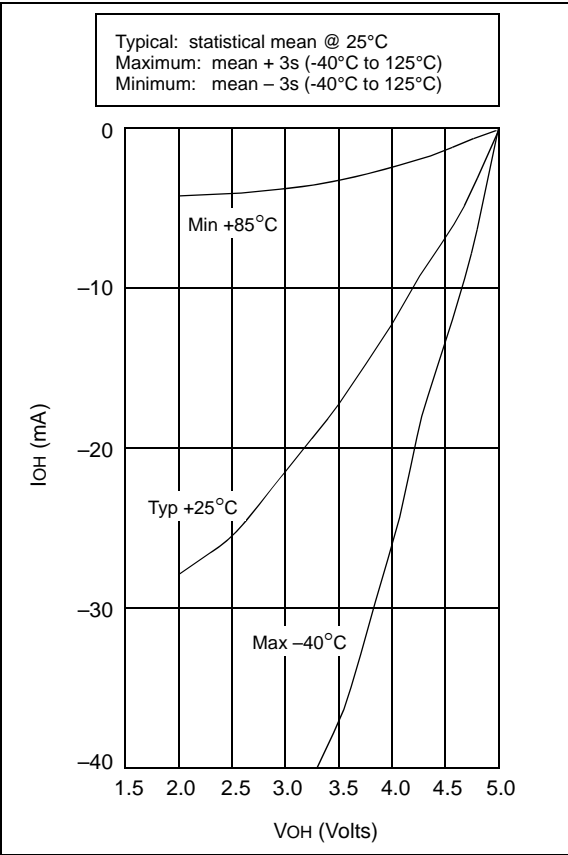


FIGURE 16-21: PORTA, B AND C I_{OH} vs. V_{OH}, V_{DD} = 5V



PIC16C5X

FIGURE 17-1: PIC16C54C/55A/56A/57C/58B-04, 20 VOLTAGE-FREQUENCY GRAPH, $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (COMMERCIAL TEMPS)

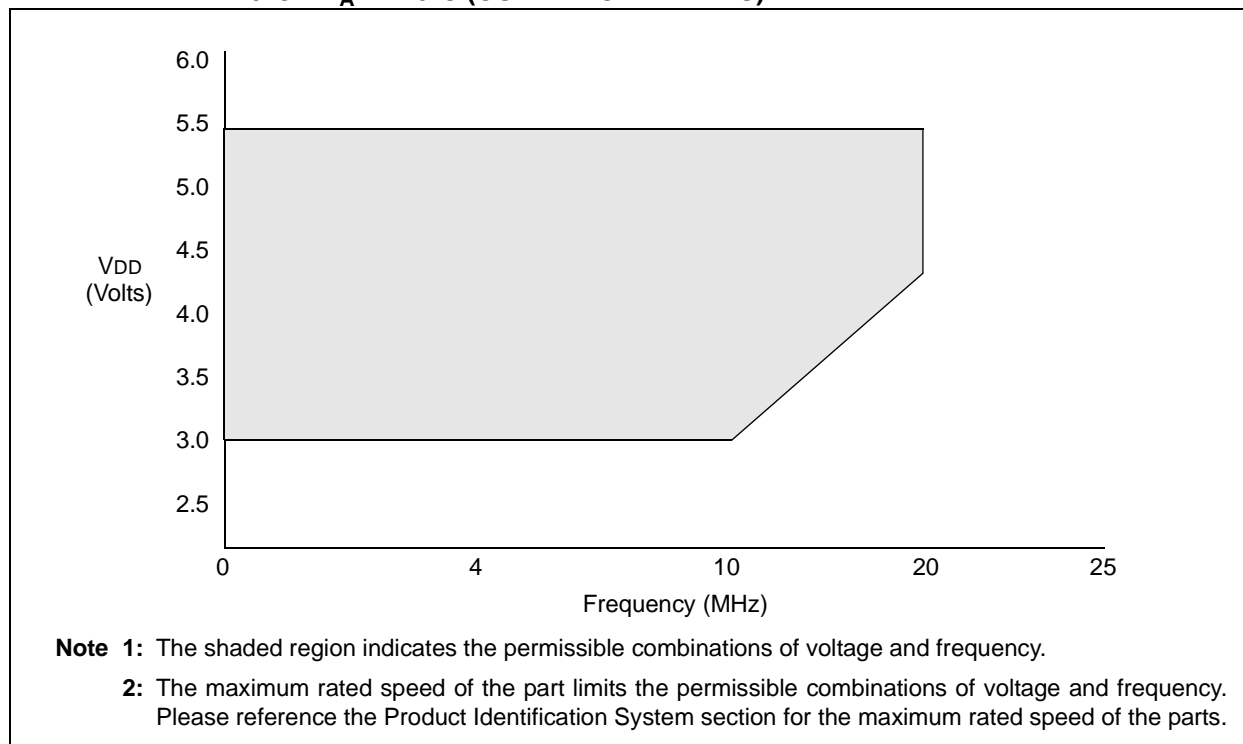
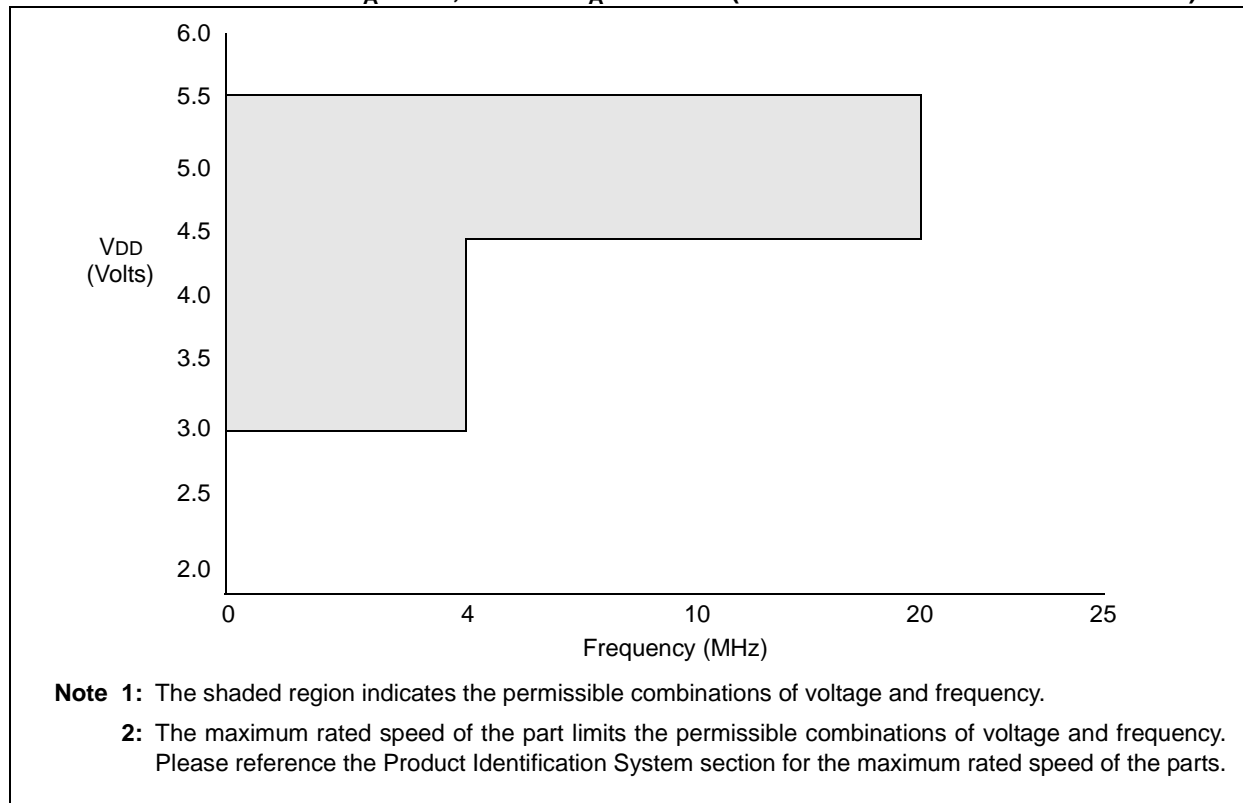


FIGURE 17-2: PIC16C54C/55A/56A/57C/58B-04, 20 VOLTAGE-FREQUENCY GRAPH, $-40^{\circ}\text{C} \leq T_A < 0^{\circ}\text{C}$, $+70^{\circ}\text{C} < T_A \leq +125^{\circ}\text{C}$ (OUTSIDE OF COMMERCIAL TEMPS)



17.2 DC Characteristics: PIC16C54C/C55A/C56A/C57C/C58B-04E, 20E (Extended) PIC16CR54C/CR56A/CR57C/CR58B-04E, 20E (Extended)

| PIC16C54C/C55A/C56A/C57C/C58B-04E, 20E PIC16CR54C/CR56A/CR57C/CR58B-04E, 20E (Extended) | | | | Standard Operating Conditions (unless otherwise specified) | | | |
|---|--------|--|----------------------------|---|---------------------------------------|----------------------------------|---|
| | | | | Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended | | | |
| Param No. | Symbol | Characteristic | Min | Typ† | Max | Units | Conditions |
| D001 | VDD | Supply Voltage | 3.0 4.5 | — — | 5.5 5.5 | V V | RC, XT, LP, and HS mode from 0 - 10 MHz from 10 - 20 MHz |
| D002 | VDR | RAM Data Retention Voltage ⁽¹⁾ | — | 1.5* | — | V | Device in SLEEP mode |
| D003 | VPOR | VDD start voltage to ensure Power-on Reset | — | VSS | — | V | See Section 5.1 for details on Power-on Reset |
| D004 | SVDD | VDD rise rate to ensure Power-on Reset | 0.05* | — | — | V/ms | See Section 5.1 for details on Power-on Reset |
| D010 | IDD | Supply Current ⁽²⁾ XT and RC ⁽³⁾ modes HS mode | — — | 1.8 9.0 | 3.3 20 | mA mA | FOSC = 4.0 MHz, VDD = 5.5V FOSC = 20 MHz, VDD = 5.5V |
| D020 | IPD | Power-down Current ⁽²⁾ | — — — — — — | 0.3 10 12 4.8 18 26 | 17 50* 60* 31* 68* 90* | μA μA μA μA μA μA | VDD = 3.0V, WDT disabled VDD = 4.5V, WDT disabled VDD = 5.5V, WDT disabled VDD = 3.0V, WDT enabled VDD = 4.5V, WDT enabled VDD = 5.5V, WDT enabled |

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.

Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.

a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.

b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.

3: Does not include current through REXT. The current through the resistor can be estimated by the formula: $I_R = V_{DD}/2R_{EXT}$ (mA) with REXT in kΩ.

17.4 Timing Parameter Symbolology and Load Conditions

The timing parameter symbols have been created with one of the following formats:

- 1. TppS2ppS
- 2. TppS

| | | | |
|--|------------------------|-----|----------------|
| T | | T | Time |
| F | Frequency | | |
| Lowercase letters (pp) and their meanings: | | | |
| pp | | mc | MCLR |
| 2 | to | osc | oscillator |
| ck | CLKOUT | os | OSC1 |
| cy | cycle time | t0 | T0CKI |
| drt | device reset timer | wdt | watchdog timer |
| io | I/O port | | |
| Uppercase letters and their meanings: | | | |
| S | | P | Period |
| F | Fall | R | Rise |
| H | High | V | Valid |
| I | Invalid (Hi-impedance) | Z | Hi-impedance |
| L | Low | | |

FIGURE 17-5: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS - PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/C58B/CR58B-04, 20

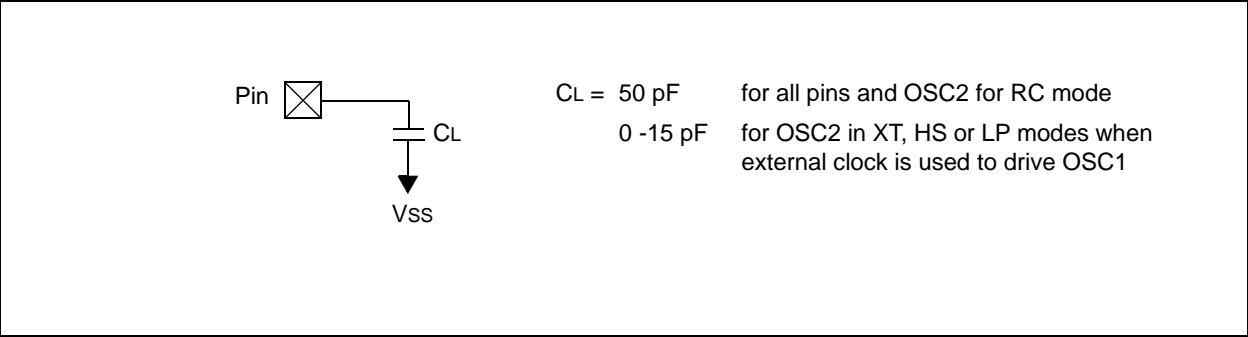


TABLE 17-1: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C5X, PIC16CR5X

| Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended | | | | | | | |
|--|------------|---------------------------------------|------|--------|-----|-------|---------------|
| Param No. | Symbol | Characteristic | Min | Typ† | Max | Units | Conditions |
| 2 | Tcy | Instruction Cycle Time ⁽²⁾ | — | 4/FOSC | — | — | |
| 3 | TosL, TosH | Clock in (OSC1) Low or High Time | 50* | — | — | ns | XT oscillator |
| | | | 20* | — | — | ns | HS oscillator |
| | | | 2.0* | — | — | μs | LP oscillator |
| 4 | TosR, TosF | Clock in (OSC1) Rise or Fall Time | — | — | 25* | ns | XT oscillator |
| | | | — | — | 25* | ns | HS oscillator |
| | | | — | — | 50* | ns | LP oscillator |

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.

When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

2: Instruction cycle period (Tcy) equals four times the input oscillator time base period.

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
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